### **GPGPU 3U VPX Supercomputer Board**





The new C535 Typhoon is ideally suited to add revolutionary GPGPU supercomputer capabilities to any 3U VPX system.

Combining the CPU and the GPGPU on a single board, the C535 replaces separate SBC + GPGPU boards, with drastically reduced power consumption.

The C535 Typhoon opens up a world of new possibilities with enhanced video and signal processing capabilities for the next generation of autonomous vehicles, avionics and flight systems, surveillance and targeting systems, EW systems, and many other applications.

#### Rugged GPGPU is Aitech

Composite Input

SDI Input

- Rugged 3U VPX HPEC Board SBC with on-board GPGPU
- NVIDIA<sup>®</sup> Jetson<sup>™</sup> TX1/TX2 Options
  - TX1 Maxwell™ GPU w/256 CUDA<sup>®</sup> cores, ARM<sup>®</sup> Cortex<sup>®</sup> A57 Quad-Core CPU, 4 GB LPDDR4, 16 GB eMMC
  - TX2 Pascal<sup>™</sup> GPU w/256 CUDA<sup>®</sup> cores, NVIDIA Denver 2 Dual-Core ARM<sup>®</sup> CPU + Cortex<sup>®</sup> A57 Quad-Core ARM<sup>®</sup> CPU, 8 GB LPDDR4, 32 GB eMMC
  - ▶ 1 TFLOPS
  - H.264/H.265 HW Encoder

**OpenVPX** Compliant

- Best Available Performance per Watt 60 GFLOPS/W
- SATA SSD with Quick Erase & Secure Erase

- Video Capture
  - SDI (SD/HD) w/dedicated H.264 encoder
  - Composite (RS-170A [NTSC]/PAL), 8 channels available simultaneously
- I/O
  - Gigabit Ethernet DVI/HDMI Output
  - UART Serial
  - USB 2.0
  - Discretes
- CUDA<sup>®</sup>, OpenGL, OpenGL ES, EGL
- Low Power Consumption
- Development Platforms Available



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**Board Architecture** 

	System on Module Option		
	NVIDIA Jetson TX2	NVIDIA Jetson TX1	
GPU	<ul> <li>NVIDIA Pascal GPU Architecture</li> <li>256 Shaders/CUDA cores</li> <li>&gt; 1 TFLOPS (fp16)</li> <li>CUDA</li> <li>OpenGL</li> <li>OpenGL ES</li> </ul>	<ul> <li>NVIDIA Maxwell GPU Architecture</li> <li>256 Shaders/CUDA cores</li> <li>1 TFLOPS (fp16)</li> <li>CUDA</li> <li>OpenGL</li> <li>OpenGL ES</li> </ul>	
CPU	<ul> <li>ARMv8 (64-bit) heterogeneous multi-processing (HMP) architecture with two CPU clusters (6 processor cores)</li> <li>NVIDIA Denver 2 Dual-Core @ 2.0 GHz, 128 KB L1 instruction cache + 64 KB L1 data cache per core, 2 MB L2 Unified Cache</li> <li>ARM<sup>®</sup> Cortex<sup>®</sup> A57 Quad-Core @ 2.0 GHz, 48 KB L1 instruction cache + 32 KB L1 data cache per core, 2 MB L2 Unified Cache</li> </ul>	ARM <sup>®</sup> Cortex <sup>®</sup> A57 Quad-Core CPU @ 1.73 GHz, 48 KB L1 instruction cache + 32 KB L1 data cache per core, 2 MB L2 Unified Cache	
RAM	8 GB LPDDR4 @ 1866 MHz, 128-bit interface	4 GB LPDDR4 @ 1600 MHz, 64-bit memory interface	
eMMC	32 GB eMMC 5.1 (boot source)	16 GB eMMC 5.1 (boot source)	
Security	<ul> <li>HW acceleration for AES 128/192/256 encryption and decryption</li> <li>HW acceleration for AES CMAC, SHA-1, SHA-256, SHA-384, and SHA-512 algorithms</li> <li>2048-bit RSA HW</li> <li>HW Random Number Generator (RNG) SP800-90</li> </ul>	<ul> <li>HW acceleration for AES 128/192/256 encryption and decryption</li> <li>HW acceleration for AES CMAC, SHA-1, and SHA-256 algorithms</li> <li>2048-bit RSA HW</li> <li>HW Random Number Generator (RNG) SP800-90</li> </ul>	
SATA SSD	Optional Mini SATA SSD with SLC/MLC Flash, Quick Erase, and Secure Erase options (additional options may be available per customer request, contact an Aitech representative for more info)		
Expansion Options	<ul> <li>Board accommodates up to two optional I/O expansion modules. Available options include:</li> <li>Composite Frame Grabber</li> <li>SDI Frame Grabber</li> <li>Included expansion modules are determined by I/O Variant, see the I/O section below for details</li> <li>(additional options may be available per customer request, contact an Aitech representative for more info)</li> </ul>		
Board Resources	<ul> <li>Multi-standard Video/JPEG Decoder/Encoder, HW Encoding for H.264/H.265</li> <li>Dynamic voltage and frequency scaling</li> <li>Temperature Sensors</li> <li>Elapsed Time Recorder</li> </ul>		
OpenVPX (VITA 65) Slot Profile	<ul> <li>SLT3-PAY-2F2T</li> <li>Payload board</li> <li>Two Fat Pipes (PCIe x4 ports)</li> <li>Two Thin Pipes (1000Base-T ports)</li> </ul>		

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without Compromise

<i>I/O</i>		I/O Variant			
		00	01	02	03
Expansion Card Options	Composite Frame Grabber	-	$\checkmark$	-	$\checkmark$
	SDI Frame Grabber	-	-	$\checkmark$	$\checkmark$
Composite Input RS-170A (NTSC)/PAL, supports simultaneous capture of all channels at full frame rates		-	8	-	8
<b>SDI Input</b> 480/60i, 576/50i, 720/60p, 1080/60i, 1080/30p, dedicated H.264 encoder		-	-	1	1
DVI (single-link) / HDMI Output		1			
USB 2.0		2			
Gigabit Ethernet (10/100/1000Base-T)		2			
Serial Ports (RS-232 UART)		2			
Discrete I/O (Single-Ended)		8 (w/TX1) or 4 (w/TX2)			

#### Software

• Linux OS pre-installed – L4T (Linux for Tegra), a lightly modified Ubuntu-based distribution

• Video capture drivers and sample applications pre-installed, in variants equipped with optional frame grabber(s)

### Mechanical

	Form Factor & Dimensions <sup>(1)</sup>	Weight
Air-Cooled	3U VPX REDI per ANSI/VITA 48.1	< 1000 g (2.2 lbs)
Conduction-Cooled	3U VPX REDI per ANSI/VITA 48.2	< 1000 g (2.2 lbs)
Notes: (1) Pitch per ordering inform	ation	

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#### Power

Input Power	Powered by standard VPX backplane connector power supplies	
Power Consumption	• ≤5W idle	
	• 8 – 10 W under typical CUDA load	
	17W when System on Module is fully utilized	
	Both System on Module options (TX1 and TX2) have similar maximum power consumption, but the TX2 is more efficient, providing higher performance than the TX1 at a given level of power consumption	
	Total power consumption depends on configuration and expansion options	

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### Environmental

	Air-Cooled		Conduction-Cooled
Specs per VITA 47	Commercial	Rugged	Rugged
Operating Temp.	AC1 (0 to +55 °C) <sup>(1)</sup>	AC3 (-40 to +70 °C) <sup>(1)</sup>	CC3 (-40 to +70 °C) <sup>(2)</sup>
Non-Operating Temp.	C1 (-40 to +85 °C)	C3 (-50 to +100 °C)	C3 (-50 to +100 °C)
Vibration	V1	V2	V3
Operating Shock	OS1	OS1	OS2
Altitude	15,000 ft.	35,000 ft.	35,000 ft.
Relative Humidity (3)	0 - 90%	0 - 95% with Acrylic (Standard),	
Conformal Coating	N/A	0 - 100% with Urethane (Optional)	

Notes: (1) Operating ambient air temperature (with sufficient airflow)

(2) Operating card edge temperature

(3) Non-condensing

## **GPGPU 3U VPX Supercomputer Board**



#### **Ordering Information**



### **Optional Accessories**

**TM535** Rear Transition Module (RTM) providing convenient access to C535 I/O interfaces via standard connectors. Supports both air and conduction-cooled C535 when installed in a compatible system.

See the TM535 datasheet for more information.

### **Development Platform**

Development platforms are available as an option, which include:

- EV535 C535 Evaluation System
- I/O Cables and Power Supply
- Software installed/configured by Aitech latest available OS release, development tools, CUDA examples

Contact your Aitech representative for additional information



### Contact Aitech

Contact your Aitech sales representative for additional product information, and for inquiries regarding customized configurations of the C535 and additional software support.



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